

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0200VT-1

This module uses ROHS material

For Customer's Acceptance:

	-
Customer	
Approved	
Comment	

This specification may change without prior notice in order to improve performance or quality. Please contact Multi-Inno for updated specification and product status before design for this product or release of this order.

Revision	1.0
Engineering	
Date	2013-04-20
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2013-04-20	First Release	



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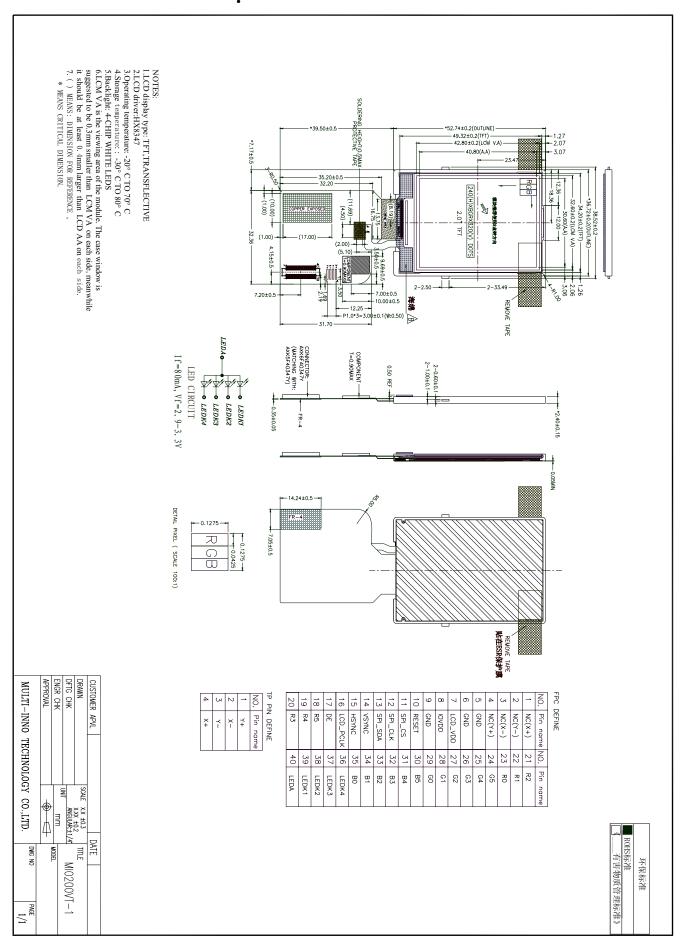


■ GENERAL INFORMATION

Item of general information	Contents	Unit
LCD Type	TFT/Transflective	/
Recommended viewing direction	8:00	O' Clock
Module area (W \times H \times T)	36.72×52.74×2.40	mm ³
Viewing area (W×H)	32.60×42.80	mm^2
Active area (W×H)	30.60×40.80	mm ²
Number of Dots	240BGR×320	/
Pixel pitch (W × H)	0.1275×0.1275	mm^2
Driver IC	HX8347	/
Interface Type	RGB+SPI interface	/
Input voltage	2.8	V
Module power consumption	270	mw
Backlight Type	4 LEDs	/



■ EXTERNAL DIMENSIONS





■ ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Supply voltage for logic	LCD_VDD/IOVCC	-0.3	4.6	V
Input voltage	Vt	-0.3	IOVDD+0.5	V
Operating temperature	Тор	-20	70	°C
Storage temperature	TST	-30	80	°C
Humidity	RH	-	90%(Max60 °C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, NOT more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

■ ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter of DC characteristics	Symbol	Min	Тур	Max	Unit
Supply voltage for logic	LCD_VDD	2.3	2.8	3.3	V
I/O power supply	IOVDD	1.65	2.8	3.3	V
Input Current	Icc	-	4.9	7.5	mA
Input voltage 'H' level	VIH	0.7IOVDD	-	IOVDD	V
Input voltage 'L' level	VIL	GND	-	0.3IOVDD	V
Output voltage 'H' level	VOH	0.8IOVDD	-	IOVDD	V
Output voltage 'L' level	VOL	GND	-	0.2IOVDD	V



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■ BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	2.9	3.1	3.3	V	If=80mA;Ta=25°C
Number of LED	-	_	4	-	Piece	-
Connection mode	P	-	Parallel	-	-	-

Using condition: constant current driving method If=80mA(+/-10%).

■ ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time	Tr+ Tf		-	35	55	ms	FIG 1.	4
Contrast ratio	Cr	θ=0°	39	78	-		FIG 2.	1
Luminance uniformity	δ WHITE	Ø=0° Ta=25°C	70	-	-	%	FIG 2.	3
Surface Luminance	Lv		190	240	-	cd/m ²	FIG 2.	2
		Ø = 90°	20	30	_	deg	FIG 3.	
Viewing angle	θ	Ø = 270°	50	60	-	deg	FIG 3	6
range	H	$\emptyset = 0_{\circ}$	40	50	-	deg	FIG 3	
		Ø = 180°	30	40	-	deg	FIG 3	
NTSC ratio	-	-	-	41	-	%	-	-
Reflectance	-	-	-	8.5	-	%	-	-
	Red x		0.5079	0.5579	0.6079	-		
	Red y		0.2718	0.3218	0.3718	-		
CIE (x, y)	Green x	$\theta=0^{\circ}$	0.2582	0.3082	0.3582	-		
chromaticity	Green y	∅=0°	0.5026	0.5526	0.6026	-	FIG 2.	5
CIE	Blue x	Ta=25°C	0.1173	0.1673	0.2173	-	110 2.	
	Blue y	14 25 0	0.1051	0.1551	0.2051	-		
	White x		0.2297	0.2897	0.3497	-		
	White y		0.2652	0.3252	0.3852	-		

Contrast Ratio(CR) is defined mathematically by the following formula. Note1. information see FIG 2.:

Average Surface Luminance with all white pixels (P1, P2, ·····) Contrast Ratio(CR) Average Surface Luminance with all black pixels (P1, P2,)



Note2. Surface luminance is the LCD surface luminance with all white pixels. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, ·····)

Note3. The uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position, and then dividing the maximum luminance of all white pixels by minimum luminance of all white pixels. For more information see FIG 2.

Note4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1..

Note5. CIE(x, y) chromaticity is the Center point value. For more information see FIG 2.

Note6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of conrast ratio is 10; For monochrome and color stn module, the specific value of conrast ratio is 2. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on CS-2000 photo detector.

Note8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle

FIG.1. The definition of Response Time

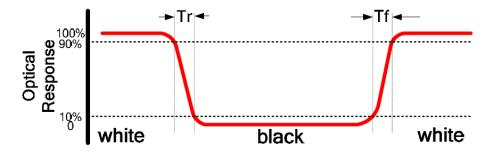
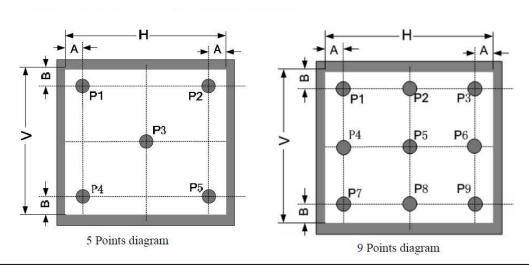


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity



P.8



Fig2 Note1 For TFT Module Test point:9 points(as 9 Points diagram)

A: H/6 (if AA size \leq 4.0inch); H/10 (if AA size \geq 4.0inch)

B: V/6 (if AA size \leq 4.0inch); V/10 (if AA size \geq 4.0inch)

H,V: Active Area(AA) size

Measurement instrument: CS-2000; Light spot size ∅=5mm, 350mm distance from the LCD surface to detector lens.

Fig2 Note2 For non-TFT Module and Dot-Matrix type Module

- If the minimum side size is bigger than 20 mm, the testing method is the same as TFT module. 2.1
- 2.2 If the minimum side size is less than 20 mm, then testing 5 point datas (as 5 Points diagram), Both A and B are 5 mm.
- 2.3 Measurement instrument: CS-2000 is priority selected to measure. Light spot size ∅=5mm, 350mm distance from the LCD surface to detector lens.
- 2.4 Measurement instrument: ConoScope will be selelected to measure If CS-2000 cannot meet the measurement requirement.

Light spot size \emptyset =0.2-2.0mm. About 2-3mm distance from the LCD surface to detector lens, but suggest to confirm the best distance on focusing the picture to be clearest when actually measuring.

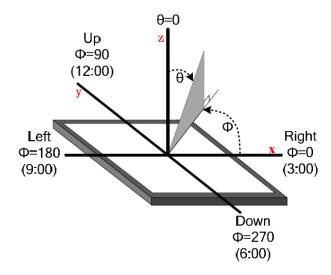
Fig2 Note3 For non-TFT Module and non-Dot-Matrix type Module

The test point is defined by the fact size and shape of module, but the center point and four edges should be selected.

- 3.1 Measurement instrument: CS-2000 is priority selected to measure.. Light spot size \emptyset =5mm, 350mm distance from the LCD surface to detector lens.
- Measurement instrument: ConoScope will be selelected to measure If CS-2000 cannot meet the measurement requirement.

Light spot size ∅=0.2-2.0mm. About 2-3mm distance from the LCD surface to detector lens, but suggest to confirm the best distance on focusing the picture to be clearest when actually measuring.

FIG.3. The definition of viewing angle



■ INTERFACE DESCRIPTION

Interface NO.	Symbol	I/O or connect to	Description	When not in use
1	NC(X+)	TP driver	Touch panel coordinate in the right side of envisage drawing.	OPEN
2	NC(Y-)	TP driver	Touch panel coordinate in the down side of envisage drawing.	OPEN
3	NC(X-)	TP driver	Touch panel coordinate in the left side of envisage drawing.	OPEN
4	NC(Y+)	TP driver	Touch panel coordinate in the up side of envisage drawing.	OPEN
5	GND	Power Supply	Power ground pin.	-
6	GND	Power Supply	Power ground pin.	-
7	LCD_VDD	Power Supply	Power Supply, 2.3 to 3.3V(Driver power supply voltage range)	-
8	IOVDD	Power Supply	IOVDD = 1.65 to 3.3V (Logic IO power supply voltage range)	-
9	GND	Power Supply	Power ground pin.	-
10	RESET	I Host processor	Reset pin. Setting either pin low initializes the LSI. Must be reset after power is supplied.	-
11	SPI_CS	I Host processor	Chip select signal. Low: chip can be accessed; High: chip cannot be accessed.	GND
12	SPI_CLK	I Host processor	Clock pin of serial interface. server as serial data clock in serial bus system interface	-
13	SPI_SDA	I/O Host processor	Serial data input pin and output pin in serial bus system interface. The data is inputted on the rising edge of the CLK signal.	OPEN
14	VSYNC	I Host processor		GND
15	HSYNC	I Host processor	Horizontal synchronizing signal in RGB interface	GND
16	LCD_PCLK	I Host processor	Dot clock signal in RGB interface.	GND
17	DE	I Host processor	Data ENABLE signal in RGB I/F mode	GND
18	R5			
19	R4	_		
20	R3	I/O Host	Red Data Signal.	OPEN/
21	R2	processor	Too Data Signar.	GND
22	R1	1		
23	R0			
24	G5	1		
25	G4	I/O Host	Green Data Signal.	OPEN /
26	G3	processor	2-277 2 000 2 2000	GND
27	G2			



			T	
28	G1	I/O Host	Green Data Signal.	OPEN /
29	G0	processor	Green Data Signal.	GND
30	B5			
31	B4			
32	B3	I/O Host	Blue Data Signal.	OPEN /
33	B2	processor	Blue Data Signal.	GND
34	B1			
35	B0			
36	LEDK4	LED driver	LEDK4(CATHODE)	OPEN
37	LEDK3	LED driver	LEDK3(CATHODE)	OPEN
38	LEDK2	LED driver	LEDK2(CATHODE)	OPEN
39	LEDK1	LED driver	LEDK1(CATHODE)	OPEN
40	LEDA	LED driver	LED ANODE.	OPEN

■ REFERENCE APPLICATION CIRCUIT

Please consult our technical department for detail information.



■ RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	80±2°C/200 hours	
2	Low Temperature Storage	-30±2°C/200 hours	Inspection after 2~4hours storage at room temperature, the sample shall be free from
3	High Temperature Operating	70±2°C/120 hours	defects: 1.Air bubble in the LCD;
4	Low Temperature Operating	-20 ± 2 °C/120 hours	2.Sealleak; 3.Non-display;
5	Temperature Cycle storage	$-20\pm2^{\circ}\text{C} \sim 25 \sim 70\pm2^{\circ}\text{C} \times 10 \text{ cycles}$ (30min.) (5min.) (30min.)	4.missing segments; 5.Glass crack;
6	Damp proof Test operating	$50^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH}/120 \text{ hours}$	6.Current Idd is twice higher than initial value.
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time	

Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance \geq 10M Ω) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



MODULE NO.: MI0200VT-1 Ver 1.0

■ INSPECTION CRITERION

This specification is made to be used as the standard acceptance/rejection criteria for Normal LCM Product.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

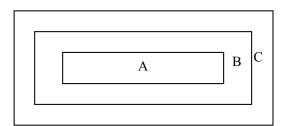
Minor defect: AQL 1.5

2. Inspection condition

- •Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40$ W light intensity, all directions for inspecting the sample should be within 45 ° against perpendicular line. (Normal temperature $20\sim25$ °C and normal humidity $60\pm15\%$ RH).
 - Driving voltage

The Vop value from which the most optimal contrast can be obtained near the specified Vop in the specification (Within ± 0.5 V of the typical value at 25°C.).

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.





4.Inspection Standard 4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	

4. 2 Cosmetic Defect

4.2.1 Module Cosmetic Criteria

Item	Judgement Criterion	Partition
Difference in Spec.	None allowed	Major
Pattern peeling	No substrate pattern peeling and floating	Major
Soldering defects	No soldering missing	Major
	No soldering bridge	Major
	No cold soldering	Minor
Resist flaw on Printed Circuit Boards	visible copper foil (∅0.5mm or more) on substrate pattern	Minor
Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed Ø0.2mm)	Minor Minor
Stain	No stain to spoil cosmetic badly	Minor
Plate discoloring	No plate fading, rusting and discoloring	Minor
Solder amount 1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
2. Flat packages 3. Chips	Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'. Lead form to be assume over solder. $(3/2) H \ge h \ge (1/2) H$	Minor
Solder ball/Solder	a. The spacing between solder ball and	Minor
splash	the conductor or solder pad $h \ge 0.13 mn$ The diameter of solder ball $d \le 0.15 mm$. b. The quantity of solder balls or solder Splashes isn't beyond 5 in 600 mm ² .	Minor Major
		b. The quantity of solder balls or solder



c. Solder balls/Solder splashes do not violate minimum electrical clearance. d. Solder balls/Solder splashes must be entrapped/encapsulated Or attached to the metal surface . NOTE: Entrapped/encapsulated/attached is intended to mean	
that normal service environment of the product will not cause a solder ball to become dislodged.	

4.2.2Cosmetic Criteria (Non-Operating)

No.	Defect	Judgment Criterion		
1	Spots	In accordance with Screen Cosmetic Criteria (Operating) No.1.		
2	Lines	In accordance with Screen Cosmetic Criteria (Operating) No.2.		
3	Bubbles in polarizer			
		Size : d mm	Acceptable Qty in active area	
		d ≤ 0.3	Disregard	
		$0.3 < d \le 1.0$	3	
		$1.0 < d \le 1.5$	1	
		1.5 < d	0	
4	Scratch	In accordance with spots and lines operating cosmetic criteria. When the		
		light reflects on the panel surface, the scratches are not to be remarkable.		
5	Allowable density	Above defects should be separated more than 30mm each other. Mine		
6	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels.		
		Back-lit type should be judged with back-lit on state only.		
7	Contamination	Not to be noticeable.		



4. 2. 3 Cosmetic Criteria (Operating)

No.	Defect	J	Judgment Crit	terion	Partition
1	Spots				Minor
		Lcd size Size : d mm Acceptable Qty in active area		Acceptable Oty in active area	
		200 5120	d≤0.1	Disregard	
		Lcd size≤	0.1 <d≤0.2< td=""><td>2</td><td></td></d≤0.2<>	2	
		8.0'	0.2 <d≤0.3< td=""><td>0</td><td></td></d≤0.3<>	0	
			0.3 < d	0	
			d ≤0.1	Disregard	
		Lcd size>8.0'	0.1 <d≤0.3< td=""><td>10</td><td></td></d≤0.3<>	10	
			0.3≤d≤0.5	5	
			0.5 < d	0	
		Note: Including pin holes and defective dots which must be within one pixel size; Total defective point shall not exceed 6 pcs no more than 8 inch LCD and 10PCS for more than 8 inch LCD. B) Unclear			
		Lcd size	Size : d mm	Acceptable Qty in active area	
			d≤0.2	Disregard	
		Lcd size≤	$0.2 < d \le 0.5$		
		8.0'	$0.5 < d \le 0.7$		
			0.7 <d< td=""><td>0</td><td></td></d<>	0	
			d≤0.2	Disregard	
		\perp Lcd size $> 8.0'$	0.2 <d≤0.5< td=""><td></td><td></td></d≤0.5<>		
		Led Size > 0.0	0.5 <d≤0.7< td=""><td></td><td></td></d≤0.7<>		
			$0.7 < d \le 1.0$ $1.0 < d$	0	
2	Lines	Note: Total defective point shall not exceed 6 pcs for no more than 8 inch LCD and 10PCS for more than 8 inch LCD.			Minor
2	Lines	A) Clear			Millor
			$] \qquad ^{(0)}$		
		2.0 (6)		See No. 1	
				W W	
		0.02 0.	.05	0.1	
		Note: () - Acceptable Qty in active area L - Length (mm) W - Width (mm) \infty - Disregard B) Unclear L (0)			
		2.0	0.3	See No. 1 0.5	
		'Clear' = the shade and LCD operation voltage chang	size of the line ging .the defect size of the li	e or dot are not changed with the clooks very apparent. ne or dot are changed with the	



3	Rubbing line	Not to be noticeable.	Minor
4	Allowable density	Above defects should be separated more than 10mm each other.	Minor
5	Rainbow	Not to be noticeable.	Minor
6	Dot size	To be 95% ~ 105% of the dot size (Typ.) in drawing. Partial defects of each dot (ex. pin-hole) should be treated as 'Spot'. (see Screen Cosmetic Criteria (Operating) No.1)	Minor
7	Uneven brightness (only back-lit type module)	Uneven brightness must be BMAX / BMIN ≤ 2 - BMAX : Max. value by measure in 5 points - BMIN : Min. value by measure in 5 points Divide active area into 4 vertically and horizontally. Measure 5 points shown in the following figure.	Minor
		0 0	
		O : Measuring points	

Note:

- (1) Size : d = (long length + short length) / 2
- (2) The limit samples for each item have priority.
- (3) Complex defects are defined item by item, but if the numbers of defects are defined in above table, the total number should not exceed 10.
- (4) In case of 'concentration', even the spots or the lines of 'disregarded' size should not allowed. Following three situations should be treated as 'concentration'.
 - 7 or over defects in circle of Ø5mm.
 - 10 or over defects in circle of \emptyset 10mm.
 - 20 or over defects in circle of \(\infty 20mm. \)



PRECAUTIONS FOR USING LCD MODULES

1 **Handing Precautions**

- The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- The polarizer covering the display surface of the LCD module is soft and easily scratched. 1.4 Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.



- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.

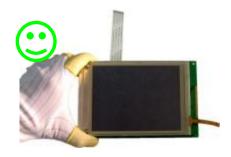


2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Transportation Precautions

- 3.2.1 During shipment, please handle with care. The packaging bag can not be broken, step on trap. Packaging Carton layer height can not be over two meters.
- 3.2.2 The transportation process should pay attention to the waterproof and moisture-proof measures. Product can not be watering. Ethylene sealed bags can not be unsealed.

3.3 Others

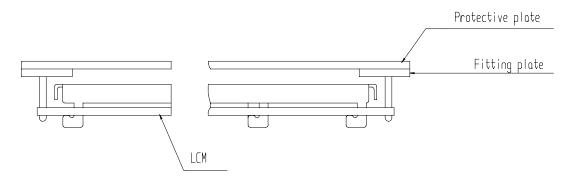
- 3.3.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.3.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.3.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.3.3.1 Exposed area of the printed circuit board.
 - 3.3.3.2 -Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

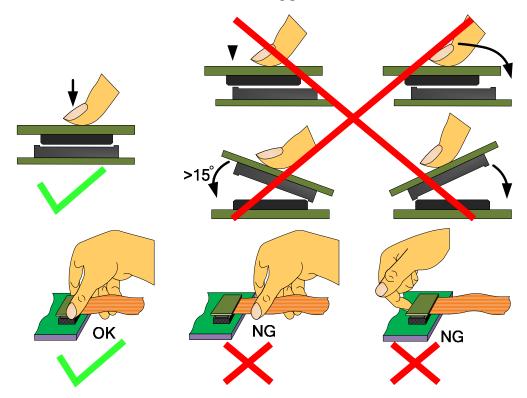
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.





- 4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.
- 4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.